

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







PRODUCT NUMBER: TAS-A2NB1-FAH

Specification

Small Form Factor Pluggable

Duplex LC Receptacle - SFP+

Optical Transceivers

10 Gigabit Ethernet 10GBASE-LR



Ordering Information

TAS-A2NB1-FAH

Voltage / Temperature 1. $3.3V / -40^{\circ}C \sim +85^{\circ}C$

Model Name	Voltage	Category	Device type	Interface	LOS	Temperature	Distance	Latch Color
TAS-A2NB1-FAH	3.3V	With DDMI	1310 nm DFB	AC / AC Coupling	LVTTL	-40°C~+85°C	10km	Blue

PRODUCT NUMBER: TAS-A2NB1-FAH

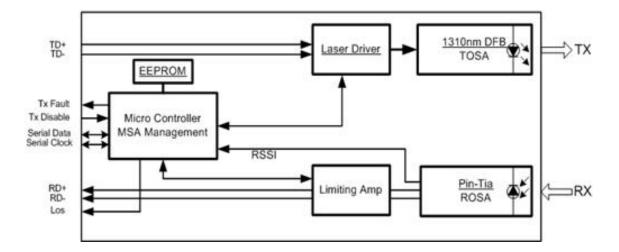
Features

- Optical Interface compliant to IEEE 802.3ae 10GBASE-LR/LW
- Compliant with SFP+ MSA
- > Data Rate 10.3125Gbps
- 1310nm DFB TOSA and PIN ROSA
- > Applicable for 10 km SMF connection
- > LC duplex receptacle
- Low power dissipation (< 1W)</p>
- > Hot Pluggable
- > All-metal housing for superior EMI performance
- > Built in digital diagnostic Functions
- > Operating case temperature range: Commercial Temperature -40°C ~ 85°C
- > ROHS Compliant

Applications

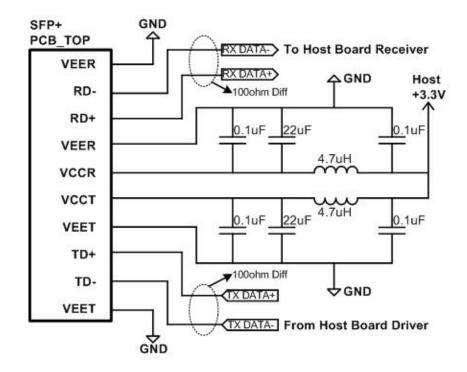
- > 10GBASE-LR 10Gigabit Ethernet
- High-speed storage area networks
- > Computer cluster cross-connect
- Custom high-speed data pipes

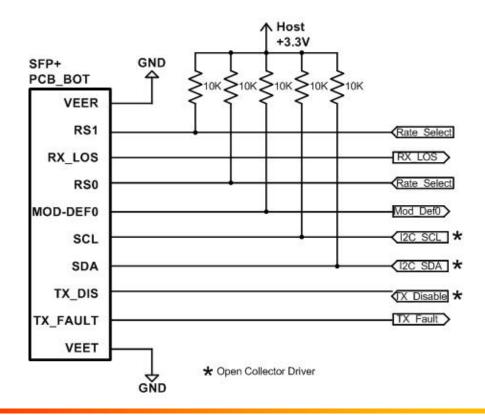
Transceiver Block Diagram





Proposed Applications Schematics



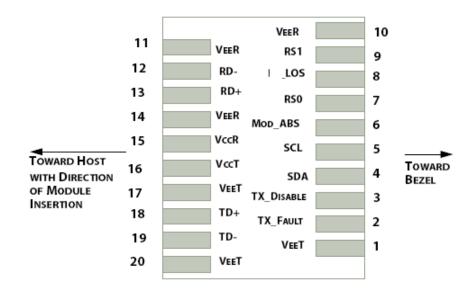


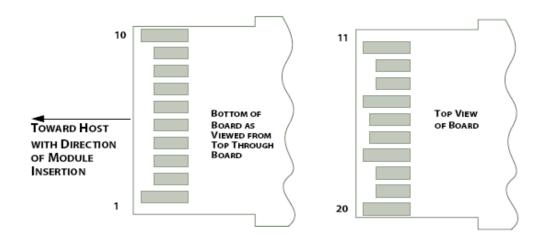
Page 3

Version 1.0



Pin Definition and Descriptions





Page 4



PIN	Logic	Symbol	Name / Description	Note
1		VeeT	Module Transmitter Ground	1
2	LVTTL-O	TX_Fault	Module Transmitter Fault	2
3	LVTTL-I	TX_Dis	Transmitter Disable; Turns off transmitter laser output	3
4	LVTTL-I/O	SDA	2-Wire Serial Interface Data Line	
5	LVTTL-I	SCL	2-Wire Serial Interface Clock	
6		Mod_ABS	Module Absent, connected to VeeT or VeeR in the module	
7	LVTTL-I	RS0	Rate Select 0, optionally controls SFP+ module receiver. When high input signaling rate> 4.25 GBd and when low input signal rate ≤ 4.25 GBd.	
8	LVTTL-O	RX_LOS	Receiver Loss of Signal Indication	
9	LVTTL-I	RS1	Rate Select 1, optionally controls SFP+ module transmitter. When high input signaling rate > 4.25 GBd and when low input signal rate ≤ 4.25 GBd.	
10		VeeR	Module Receiver Ground	1
11		VeeR	Module Receiver Ground	1
12	CML-O	RD-	Receiver Inverted Data Output	
13	CML-O	RD+	Receiver Data Output	
14		VeeR	Module Receiver Ground	1
15		VccR	Module Receiver 3.3 V Supply	
16		VccT	Module Transmitter 3.3 V Supply	
17		VeeT	Module Transmitter Ground	1
18	CML-I	TD+	Transmitter Non-Inverted Data Input	
19	CML-I	TD-	Transmitter Inverted Data Input	
20		VeeT	Module Transmitter Ground	1

Note:

- 1. Module ground pins are isolated from the module case and chassis ground within the module.
- 2. Shall be pulled up with 4.7k to 10k ohm to a voltage between 3.15V and 3.45V on the host board.
- 3. Shall be pulled up with 4.7k to 10k ohm to VccT in the module.



Absolute Maximum Ratings

Parameters	Symbol	Min.	Max.	Unit
Power Supply Voltage	V _{CC}	0	3.6	V
Storage Temperature	Tc	-40	85	°C
Relative Humidity	RH	5	95	%
Optical Receiver Power (Damage)	Pmax		1.5	dBm

Recommended Operating Environment

Parameters	Symbol	Min.	Typical	Max	Unit
Power Supply Voltage	V_{CC}	3.135	3.3	3.465	V
Operating Case Temperature	T _C	-40		85	°C
Power Supply Current	lcc			300	mA
Power Consumption			800	1000	mW
Data rate			10.3125		Gbps



Optical Characteristics

Parameter		Symbol	Min.	Тур.	Max	Unit	Notes		
Transmitter									
Average Launch Power		Po	-8.2		0.5	dBm			
Center	wavelength	λ _c	1260		1355	nm			
Side M	lode Suppression Ratio	SMSR	30			nm			
Extinct	tion ratio	E _R	3.5			dB			
Transr penalty	mitter and dispersion y(max)	TDP			3.2	dB			
Optica	l power OMA	P _{OMA}	-5.2			dBm			
OMA-	TDP	P _{OMA-TDP}	-6.2			dBm			
Average launch power of OFF transmitted		P _{off}			-30	dBm			
RIN ₁₂ C	OMA	RIN			-128	dB/Hz			
Optica	Optical Return Loss Tolerance		12			dB			
Output	t eye	Compliant with IEEE802.3ae eye mask							
		F	Receiver						
Center	wavelength	λ _c	1260		1355	nm			
Averag	ge receiver power(max)	P _{max}			0.5	dBm			
Averaç	ge receiver power(min)	P _{min}	-14.4			dBm			
Receiv	ver Reflectance	R _{rx}			-12	dB			
Receiv	ver Sensitivity in OMA				-12.6	dBm			
Stress	ed Sensitivity in OMA				-10.3	dBm	1		
Vertica	al eye closure penalty		2.2			dB	2		
Stress	ed eye jitter		0.3			Ulp-p	1		
1.00	Assert	LOS _A	-30			dBm			
LOS	Deassert	LOS _D			-12	dBm			
LOS H	lysteresis	LOS _H	0.5			dB			

Note:

- 1. Receiver sensitivity is informative. Stressed receiver sensitivity shall be measured with conformance test signal for BER = 1×10^{-12} .
- 2. Vertical eye closure penalty and stressed eye jitter are the test conditions for measuring stressed receiver sensitivity. They are not the required characteristic of the receiver.



Electrical Characteristics

Parameter	Symbol	Min.	Typical	Max	Unit	Notes				
Data Rate		-	10.3125	-	Gbps					
	Transmitter									
Transmitter Differential Input Voltage	V _{IN}	180	-	700	mV					
Transmitter Disable (TX-	V _{IH}	2		Vcc	V					
Disable)	V _{IL}	Vee		Vee+0.8	V					
		Receive	er							
Receiver Differential Output Voltage	Vo	300	-	850	mV					
Loss of Signal (LOS)	V _{OH}	2		Vcc	V					
Loss of Signal (LOS)	V _{OL}	Vee		Vee+0.8	V					
Rx Output Rise and Fall Time	Tr/Tf	30			ps	20% to 80%				

Control And Status I/O Timing Characteristics

Parameter	Symbol	Min	Max	Unit	Condition
TX Disable Assert Time	t_off		10	μs	Time from rising edge of TX Disable to when the optical output falls below 10% of nominal
TX Disable Negate Time	t_on		1	ms	Time from falling edge of TX Disable to when the modulated optical output rises above 90% of nominal
Time to initialize, including reset of TX_Fault	t_init		300	ms	From power on or negation of TX Fault using TX Disable
TX Fault Assert Time	t_fault		100	μs	Time from fault to TX fault on.
TX Disable to reset	t_reset	10		μs	Time TX Disable must be held high to reset TX_fault
LOS Assert Time	t_loss_on		100	μs	Time from LOS state to RX LOS assert
LOS Deassert Time	t_loss_off		100	μs	Time from non-LOS state to RX LOS deassert
Rate-Select Change Time	t_ratesel		10	μs	Time from rising or falling edge of Rate Select input until receiver bandwidth is in conformance with appropriate specification.
Serial ID Clock Rate	f_serial_clock		100	kHz	

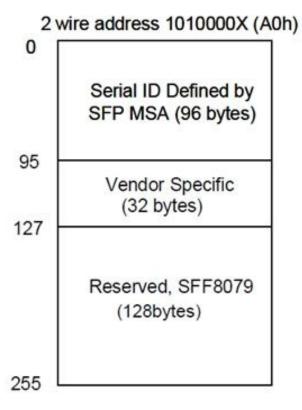
Page 8

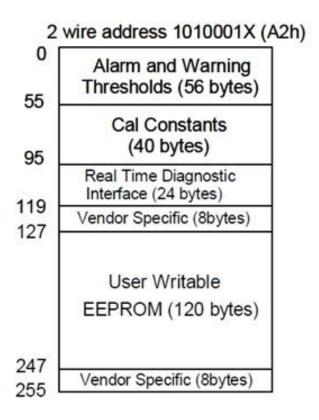


Digital Diagnostic Functions

Parameter	Symbol	Min.	Max	Unit	Notes
Temperature monitor absolute error	DMI_Temp	-3	3	degC	Over operating temp
Laser power monitor absolute error	DMI_TX	-3	3	dB	
RX power monitor absolute error	DMI_RX	-3	3	dB	-1dBm to -12dBm range
Supply voltage monitor absolute error	DMI_VCC	-0.08	0.08	V	Full operating range
Bias current monitor	DMI_Ibias	-10%	10%	mA	

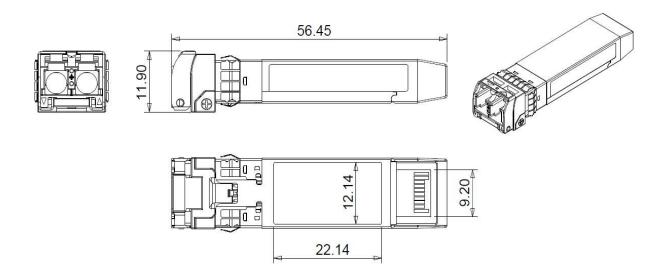
Digital Diagnostic Memory Map







Mechanical (mm)



ESD

This transceiver is specified as ESD threshold 2kV for all electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

LASER Safety

This is a Class 1 Laser Product according to IEC 60825-1:1993:+A1:1997+A2:2001. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (July 26, 2001)